

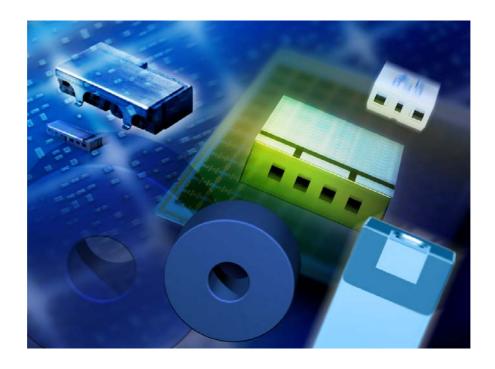
Microwave Ceramics and Modules

Filter

2-Pole Filter for DAB

B69812N1477A540

Data Sheet



Features

- SMD filter consisting of coupled resonators with stepped impedances
- (NdBa)TiO₃ ($\varepsilon_r = 88 / TC_f = 0 \pm 10 \text{ ppm/K}$) with a coating of copper (10µm) and tin (>5µm)
- Excellent reflow solderability, no migration effect due to copper/tin metallization

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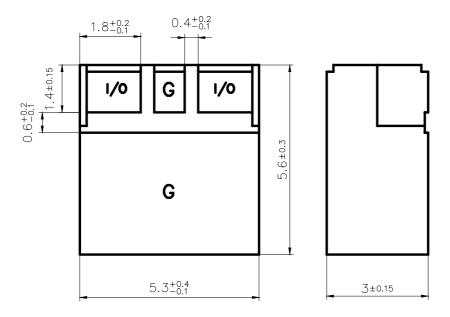
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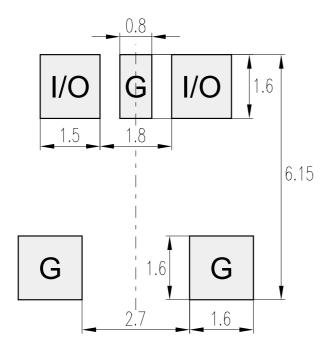
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Component drawing



View from below onto the solder terminals and view from beside

Recommended footprint



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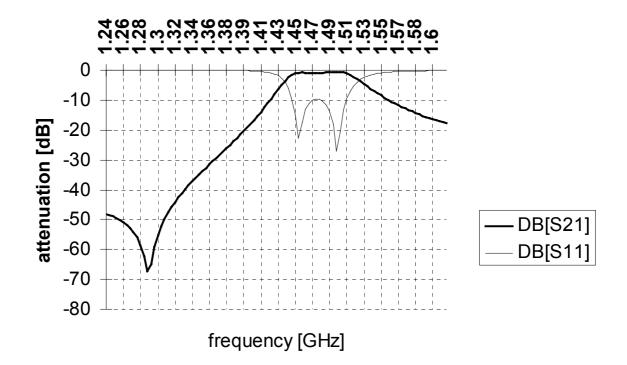
Characteristics

			min.	typ.	max.	
Center frequency		f _C	-	1472	-	MHz
Insertion loss		$lpha_{IL}$		0.9	1.5	dB
Passband		В	40			MHz
Amplitude ripple (peak - peak)		$\Delta \alpha$		0.3	1.0	dB
Standing wave ratio		SWR		1.5	2.0	
Impedance		Z		50		Ω
Attenuation	at 1242 MHz	α	40	45		dB

Maximum ratings

IEC climatic category (IEC 68-1)		- 40/+ 90/56	
Operating temperature	T_{op}	- 40 / + 90	°C

Typical Passband Characteristics



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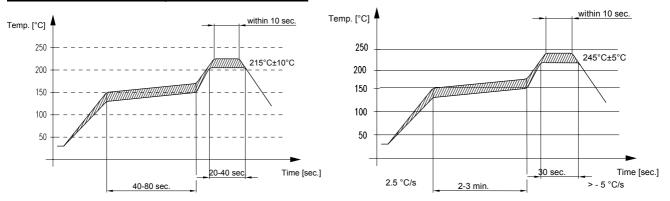
Processing information

Wettability acc. to IEC 68-2-58: ≥ 75% (after aging)

Soldering Requirements

	Profile for eutectic SnPb solder paste	Profile for leadfree solder paste	
Soldering type	reflow	reflow	
Maximum soldering temperature (measuring point on top surface of the component)	235 (max. 2 sec.) 225 (max. 10 sec.)	260 (max. 2 sec.) 250 (max. 10 sec.)	°C °C

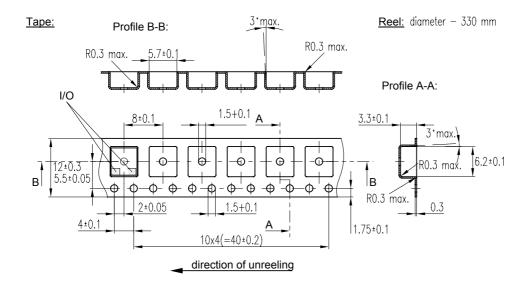
Recommended soldering conditions (infrared):



Delivery mode

• Blister tape acc. to IEC 286-3, polyester, grey

• Pieces/tape: 2000



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The information contained in this data sheet describes the type of component and shall not be considered as guaranteed characteristics. Purchase orders are subject to the General Conditions for the Supply of Products and Services of the Electrical and Electronics Industry recommended by the ZVEI (German Electrical and Electronic Manufacturers' Association), unless otherwise agreed.

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